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## Surface Mount RF PIN Switch Diode

## **Technical Data**

## **HSMP-3880**

#### **Features**

- Diodes Optimized for: Ultra-Low Distortion Switching
- Surface Mount SOT-23 Package Tape and Reel Options Available
- Low Failure in Time (FIT) Rate<sup>[1]</sup>
- Lead-free Option Available

#### Note:

1. For more information see the Surface Mount PIN Reliability Data Sheet.

## Package Lead Code Identification (Top View)



#### **Description/Applications**

The HSMP-3880 switching diode is an ultra low distortion device optimized for higher power applications to 1.5 GHz.

A SPICE model is not available for PIN diodes as SPICE does not provide for a key PIN diode characteristic, carrier lifetime.

Symbol	Parameter	Units	Absolute Maximum
I <sub>f</sub>	Forward Current (1 ms Pulse)	Amp	1
Pt	Total Device Dissipation	mW <sup>[2]</sup>	250
P <sub>iv</sub>	Peak Inverse Voltage	—	Same as V <sub>BR</sub>
Tj	Junction Temperature	°C	150
T <sub>STG</sub>	Storage Temperature	°C	-65 to 150

## Absolute Maximum Ratings $^{[1]}$ $T_{C}$ = $25^{\circ}C$

Notes:

1. Operation in excess of any one of these conditions may result in permanent damage to this device.

2. CW Power Dissipation at  $T_{\rm LEAD}$  = 25°C. Derate to zero at maximum rated temperature.

Part Number HSMP-	Series Resistance $\mathbf{R}_{\mathbf{S}}(\Omega)$	Carrier Lifetime	Reverse Recovery Time T <sub>rr</sub> (ns)	Total Capacitance C <sub>T</sub> (pF)
3880	3.8	2500	550	0.30 @ 50 V
Test Conditions	$I_{\rm F} = 1 \text{ mA}$ $f = 100 \text{ MHz}$	$I_{\rm F} = 50 \text{ mA}$ $I_{\rm R} = 250 \text{ mA}$	$\begin{array}{l} V_{\rm R} = 10 \ {\rm V} \\ I_{\rm F} = 20 \ {\rm mA} \\ 90\% \ {\rm Recovery} \end{array}$	

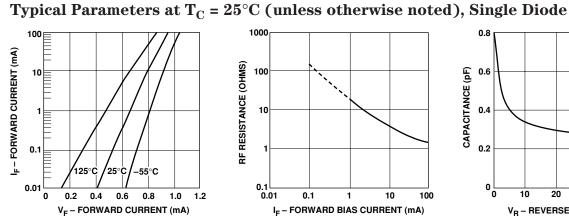
## Typical Parameters at $T_C$ = 25 $^\circ C$

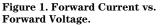
## Electrical Specifications $T_C = 25^{\circ}C$

Part Number HSMP-	Package Marking Code <sup>[1]</sup>	Lead Code	Configuration	Minimum Breakdown Voltage V <sub>BR</sub> (V)	Maximum Series Resistance R <sub>S</sub> (Ω)	Maximum Total Capacitance C <sub>T</sub> (pF)	Maximum Shunt Mode Harmonic Distortion Hmd (dBc)
3880	$\mathbf{S0}$	0	Single	100	6.5	0.40	-55
Test Conditions		$\begin{split} V_{R} = V_{BR} \\ Measure \\ I_{R} \leq 10 \ \mu A \end{split}$	$I_{\rm F} = 5 \text{ mA}$ $f = 100 \text{ MHz}$	$V_R = 50 V$ f = 1 MHz	$\begin{array}{l} 2f_{o},Z_{o}=50\;W\\ f_{o}=400\;MHz\\ P_{in}=+30\;dBm\\ 0V\;bias \end{array}$		

Note:

1. Package marking code is white.





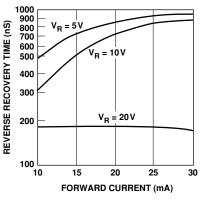
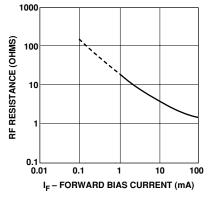
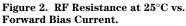
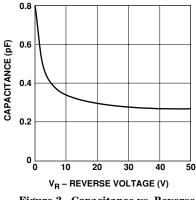
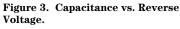


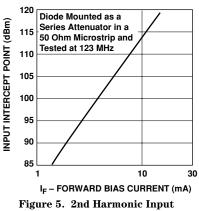
Figure 4. Typical Reverse Recovery Time vs. Reverse Voltage.





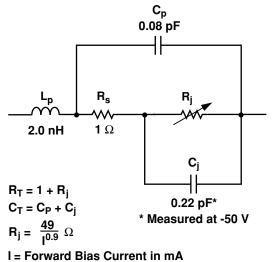




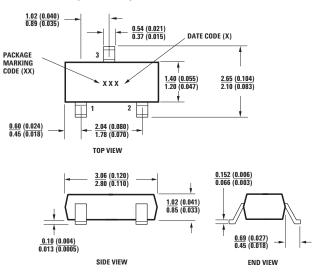


Intercept Point vs. Forward Bias Current.

**Equivalent Circuit Model HSMP-3880** 

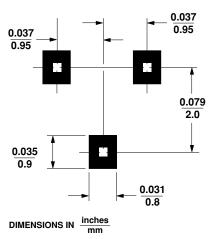


## Package Dimensions Outline 23 (SOT-23)



DIMENSIONS ARE IN MILLIMETERS (INCHES)

PC Board Footprints SOT-23



## **Package Characteristics**

Lead Material	Alloy 42
Lead Finish	Tin-Lead 85-15%
Maximum Soldering Temperature	
Minimum Lead Strength	
Typical Package Inductance	2 nH
Typical Package Capacitance	0.08 pF (opposite leads)

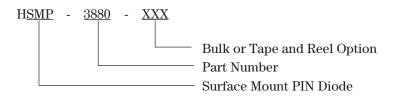
## **Profile Option Descriptions**

-BLK = Bulk -TR1 = 3K pc. Tape and Reel, Device Orientation; See Figure 6 -TR2 = 10K pc. Tape and Reel, Device Orientation; See Figure 6

Tape and Reeling conforms to Electronic Industries RS-481, "Taping of Surface Mounted Components for Automated Placement." For lead-free option, the part number will have the character "G" at the end, e.g., TR2G for a 10K pc lead-free reel.

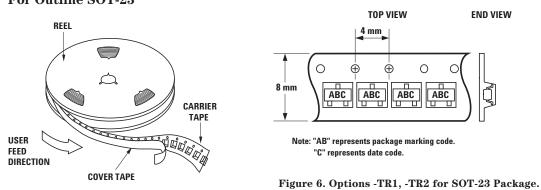
### **Ordering Information**

Specify part number followed by option under. For example:

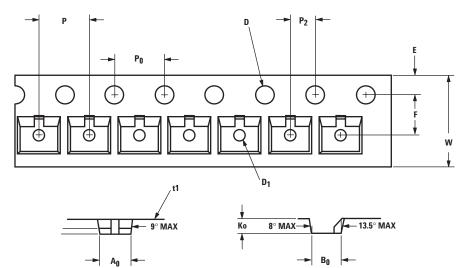




#### **Device Orientation** For Outline SOT-23



## **Tape Dimensions and Product Orientation** For Outline SOT-23



	DESCRIPTION	SYMBOL	SIZE (mm)	SIZE (INCHES)
CAVITY	LENGTH	An	$\textbf{3.15} \pm \textbf{0.10}$	$\textbf{0.124} \pm \textbf{0.004}$
	WIDTH	Bo	$\textbf{2.77} \pm \textbf{0.10}$	$\textbf{0.109} \pm \textbf{0.004}$
	DEPTH	KO	$\textbf{1.22} \pm \textbf{0.10}$	$\textbf{0.048} \pm \textbf{0.004}$
	PITCH	Р	$\textbf{4.00} \pm \textbf{0.10}$	$\textbf{0.157} \pm \textbf{0.004}$
	BOTTOM HOLE DIAMETER	D <sub>1</sub>	1.00 + 0.05	$\textbf{0.039} \pm \textbf{0.002}$
PERFORATION	DIAMETER	D	1.50 + 0.10	0.059 + 0.004
	PITCH	Po	$\textbf{4.00} \pm \textbf{0.10}$	$\textbf{0.157} \pm \textbf{0.004}$
	POSITION	E	$\textbf{1.75} \pm \textbf{0.10}$	$\textbf{0.069} \pm \textbf{0.004}$
CARRIER TAPE	WIDTH	w	8.00 +0.30 -0.10	0.315 +0.012-0.004
	THICKNESS	t1	$\textbf{0.229} \pm \textbf{0.013}$	$\textbf{0.009} \pm \textbf{0.0005}$
DISTANCE BETWEEN CENTERLINE	CAVITY TO PERFORATION (WIDTH DIRECTION)	F	$\textbf{3.50} \pm \textbf{0.05}$	$\textbf{0.138} \pm \textbf{0.002}$
	CAVITY TO PERFORATION (LENGTH DIRECTION)	P <sub>2</sub>	$\textbf{2.00} \pm \textbf{0.05}$	$\textbf{0.079} \pm \textbf{0.002}$

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